

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jin-Yuan Lee</td> <td>01/28/2001</td> </tr> <tr> <td>Mou-Shiung Lin</td> <td>01/28/2001</td> </tr> <tr> <td>Ching-Cheng Huang</td> <td>01/28/2001</td> </tr> </tbody> </table>		Name	Execution Date	Jin-Yuan Lee	01/28/2001	Mou-Shiung Lin	01/28/2001	Ching-Cheng Huang	01/28/2001		
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>Megic Corporation</td> </tr> <tr> <td>Street Address:</td> <td>21, R&D 1st Rd., Science-Based Industrial Park</td> </tr> <tr> <td>City:</td> <td>Hsinchu</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>ROC</td> </tr> </table>		Name:	Megic Corporation	Street Address:	21, R&D 1st Rd., Science-Based Industrial Park	City:	Hsinchu	State/Country:	TAIWAN	Postal Code:	ROC
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PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Patent Number:</td> <td>8368213</td> </tr> </tbody> </table>		Property Type	Number	Patent Number:	8368213						
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CORRESPONDENCE DATA											
<p>Fax Number: 8586582502</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: (858) 651-5205</p> <p>Email: usdocketing@qualcomm.com</p> <p>Correspondent Name: QUALCOMM Incorporated</p> <p>Address Line 1: 5775 Morehouse Drive</p> <p>Address Line 4: San Diego, CALIFORNIA 92121-1714</p>											
ATTORNEY DOCKET NUMBER:	092977D1										
NAME OF SUBMITTER:	Karen M Cruz										
Signature:	/Karen M Cruz/										
Date:	07/11/2013										
<p>Total Attachments: 2</p> <p>source=092977#page1.tif</p> <p>source=092977#page2.tif</p>											

CH \$40.00 8368213



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MEG01-003
09/798654

For ☒ U.S. and/or ☒ Foreign Rights
For ☒ Application or ☐ U.S. Patent
By ☒ Inventor(s) or ☐ Present Owner

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR:

Jin-Yuan Lee
Type or print name of ASSIGNOR
No. 11, Lane 4, An-Ho street
Address
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Republic of China
Nationality

Mou-shiung Lin
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Nationality

Ching-Cheng Huang
Type or print name of ASSIGNOR
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Address
Hsinchu, Taiwan
TAIWAN, R.O.C.
Nationality

ASSIGNEE:

MEGIC Corp.
21, R & D First Road
Science Based Industrial Park
Hsin-Chu, Taiwan, R.O.C.
Taiwan, R.O.C.
Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

- ☒ the entire right, title and interest
☐ an undivided _____ percent (____%) interest for the United States and its territorial possessions
(check the following box if foreign rights are also to be assigned)
☒ and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

Low Fabrication Cost, Fine Pitch And High
Reliability Solder Bump

81-25-81 88:26 TO:

FROM:8454712854

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and which is found in

- (a) ☒ U.S. patent application executed on even date herewith
 (b) ☐ U.S. patent application executed on _____
 (c) ☐ U.S. application serial no. _____ filed on _____
 (d) ☐ U.S. patent no. _____ issued _____
 (also check (e) if foreign application(s) is also being assigned)
 (e) ☐ and any legal equivalent thereof in a foreign country, including the right to claim priority

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed this

January 28, 2001 (Date of signing)

WARNING Date of signing must be the same as the date of execution of the application, if item (a) was checked above.

Jin-Yuan Lee
 Signature of Assignor(s)
Ma Shing Li
Ching-Cheng Huang

If ASSIGNOR is a legal entity complete the following information

 (Type or print the name of the above person authorized to sign on behalf of ASSIGNOR)

 Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

 Notarization or Legalization Page Added.